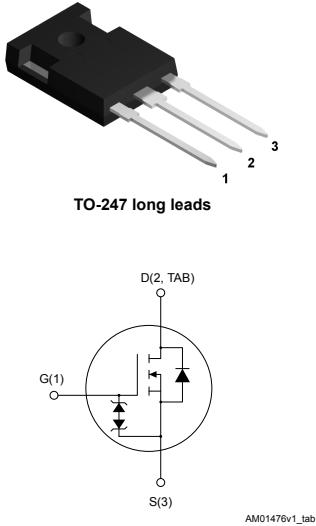


## N-channel 650 V, 51 mΩ typ., 55 A MDmesh DM6 Power MOSFET in a TO-247 long leads package

### Features



Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STWA68N65DM6	650 V	59 mΩ	55 A

- Fast-recovery body diode
- Lower R<sub>DS(on)</sub> per area vs previous generation
- Low gate charge, input capacitance and resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

### Applications

- Switching applications

### Description

This high-voltage N-channel Power MOSFET is part of the MDmesh DM6 fast-recovery diode series. Compared with the previous MDmesh fast generation, DM6 combines very low recovery charge (Q<sub>rr</sub>), recovery time (t<sub>rr</sub>) and excellent improvement in R<sub>DS(on)</sub> per area with one of the most effective switching behaviors available in the market for the most demanding high-efficiency bridge topologies and ZVS phase-shift converters.



#### Product status link

[STWA68N65DM6](#)

#### Product summary

Order code	STWA68N65DM6
Marking	68N65DM6
Package	TO-247 long leads
Packing	Tube

## 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	$\pm 25$	V
$I_D$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	55	A
$I_D$	Drain current (continuous) at $T_C = 100^\circ\text{C}$	35	A
$I_{DM}^{(1)}$	Drain current (pulsed)	172	A
$P_{TOT}$	Total power dissipation at $T_C = 25^\circ\text{C}$	431	W
$dv/dt^{(2)}$	Peak diode recovery voltage slope	100	V/ns
$di/dt^{(2)}$	Peak diode recovery current slope	1000	A/ $\mu\text{s}$
$dv/dt^{(3)}$	MOSFET dv/dt ruggedness	100	V/ns
$T_{STG}$	Storage temperature range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating junction temperature range		$^\circ\text{C}$

1. Pulse width limited by safe operating area.
2.  $I_{SD} \leq 55 \text{ A}$ ,  $V_{DS} (\text{peak}) < V_{(BR)DSS}$ ,  $V_{DD} = 400 \text{ V}$ .
3.  $V_{DS} \leq 520 \text{ V}$ .

**Table 2. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thJC}$	Thermal resistance, junction-to-case	0.29	$^\circ\text{C}/\text{W}$
$R_{thJA}$	Thermal resistance, junction-to-ambient	50	$^\circ\text{C}/\text{W}$

**Table 3. Avalanche characteristics**

Symbol	Parameter	Value	Unit
$I_{AR}$	Avalanche current, repetitive or not repetitive ( $t_p$ limited by $T_J$ max)	9	A
$E_{AS}$	Single pulse avalanche energy (starting $T_J = 25^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50 \text{ V}$ )	930	mJ

## 2 Electrical characteristics

$T_C = 25^\circ\text{C}$  unless otherwise specified

**Table 4. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	650			V
$I_{\text{DSS}}$	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V}$		1		$\mu\text{A}$
		$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V}, T_C = 125^\circ\text{C}$ <sup>(1)</sup>			100	
$I_{\text{GSS}}$	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			$\pm 5$	$\mu\text{A}$
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	3.25	4.00	4.75	V
$R_{\text{DS(on)}}$	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 24 \text{ A}$		51	59	$\text{m}\Omega$

1. Defined by design, not subject to production test.

**Table 5. Dynamic characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	3528	-	pF
$C_{oss}$	Output capacitance		-	258	-	pF
$C_{rss}$	Reverse transfer capacitance		-	1.5	-	pF
$C_{oss \text{ eq.}}^{(1)}$	Equivalent output capacitance	$V_{DS} = 0 \text{ to } 520 \text{ V}, V_{GS} = 0 \text{ V}$	-	609	-	pF
$R_G$	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	1.25	-	$\Omega$
$Q_g$	Total gate charge	$V_{DD} = 520 \text{ V}, I_D = 48 \text{ A}, V_{GS} = 0 \text{ to } 10 \text{ V}$ (see Figure 14. Test circuit for gate charge behavior)	-	80	-	nC
$Q_{gs}$	Gate-source charge		-	21.5	-	nC
$Q_{gd}$	Gate-drain charge		-	35	-	nC

1.  $C_{oss \text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 325 \text{ V}, I_D = 34 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 13. Test circuit for resistive load switching times and Figure 18. Switching time waveform)	-	25	-	ns
$t_r$	Rise time		-	32	-	ns
$t_{d(off)}$	Turn-off delay time		-	76	-	ns
$t_f$	Fall time		-	9	-	ns

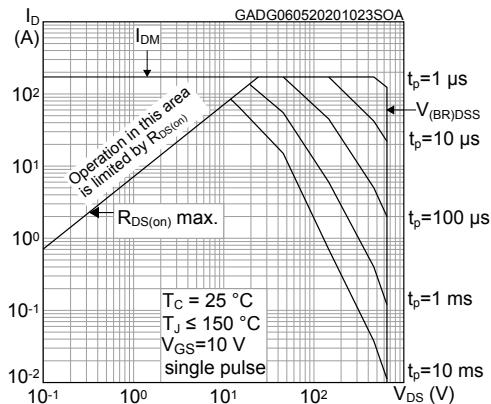
Table 7. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current		-		55	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		172	A
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS} = 0 \text{ V}$ , $I_{SD} = 48 \text{ A}$	-		0.98	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 48 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$ ,	-	135		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 60 \text{ V}$ (see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	0.641		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current		-	9.5		A
$t_{rr}$	Reverse recovery time	$I_{SD} = 48 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$ ,	-	245		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 60 \text{ V}$ , $T_J = 150 \text{ }^\circ\text{C}$ (see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	2.45		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current		-	20		A

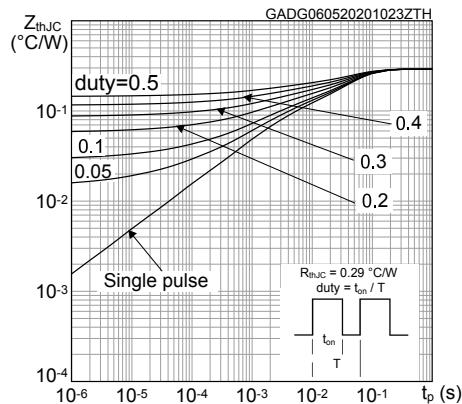
1. Pulse width is limited by safe operating area.
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)

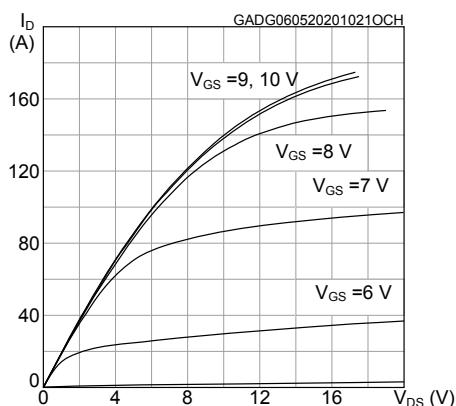
**Figure 1. Safe operating area**



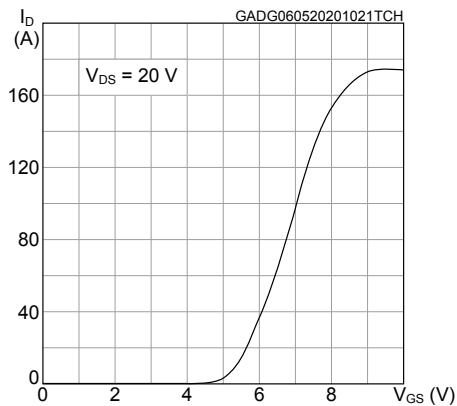
**Figure 2. Maximum transient thermal impedance**



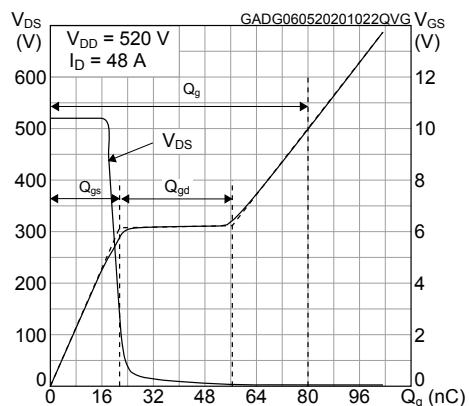
**Figure 3. Typical output characteristics**



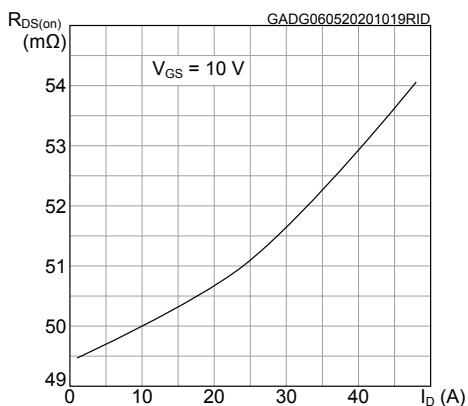
**Figure 4. Typical transfer characteristics**

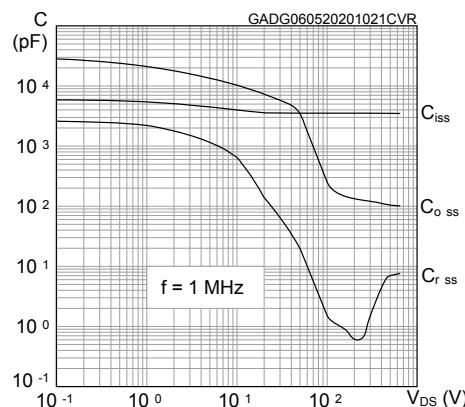
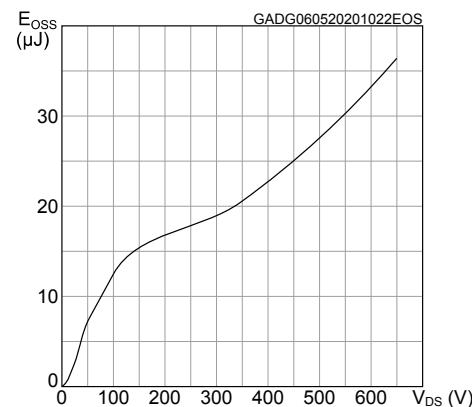
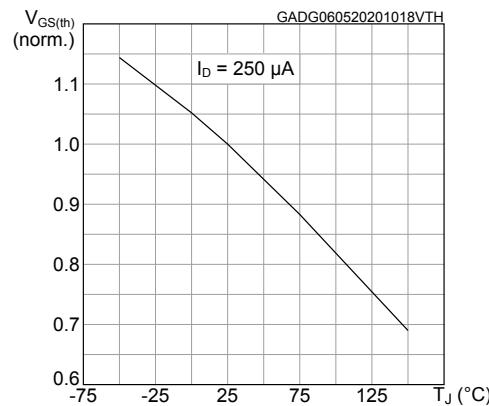
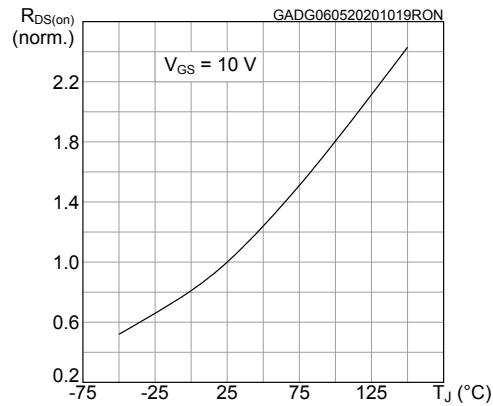
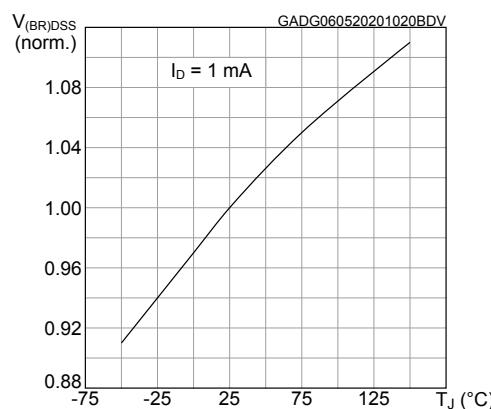
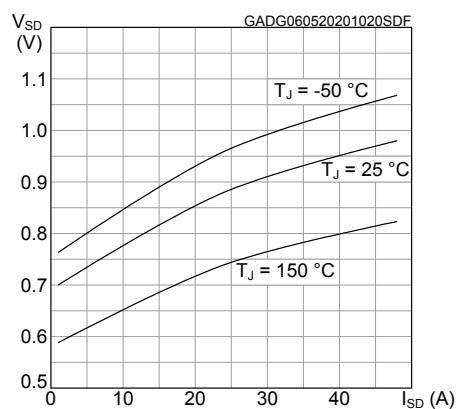


**Figure 5. Typical gate charge characteristics**



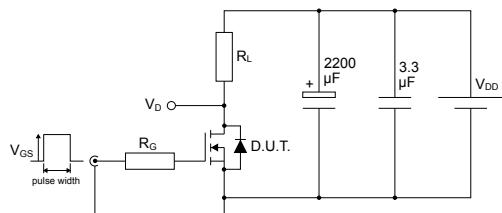
**Figure 6. Typical drain-source on-resistance**



**Figure 7. Typical capacitance characteristics**

**Figure 8. Typical output capacitance stored energy**

**Figure 9. Normalized gate threshold vs temperature**

**Figure 10. Normalized on-resistance vs. temperature**

**Figure 11. Normalized breakdown voltage vs temperature**

**Figure 12. Typical reverse diode forward characteristics**


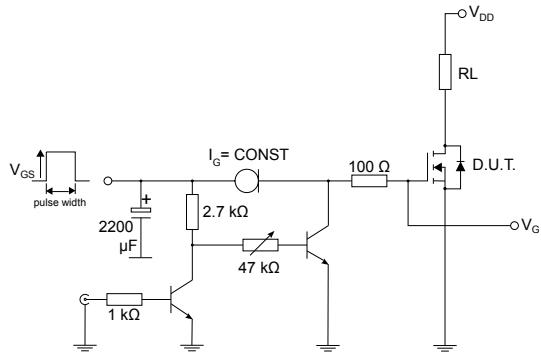
### 3 Test circuits

**Figure 13.** Test circuit for resistive load switching times



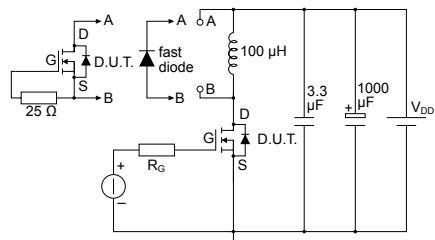
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**Figure 14.** Test circuit for gate charge behavior



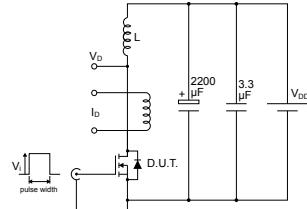
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**Figure 15.** Test circuit for inductive load switching and diode recovery times



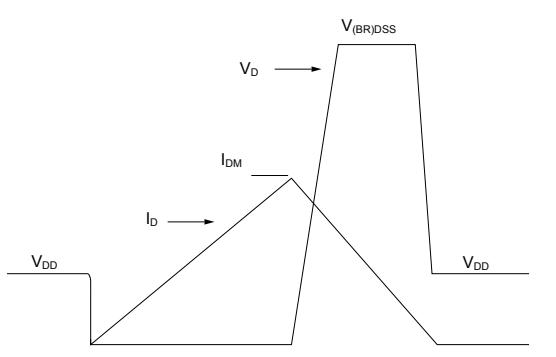
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**Figure 16.** Unclamped inductive load test circuit



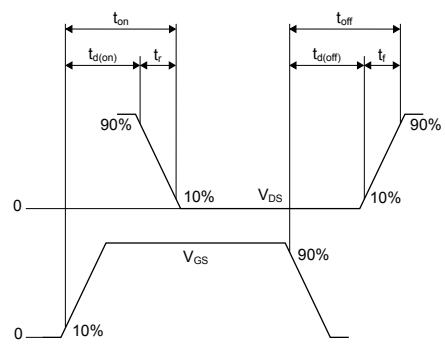
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**Figure 17.** Unclamped inductive waveform



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**Figure 18.** Switching time waveform



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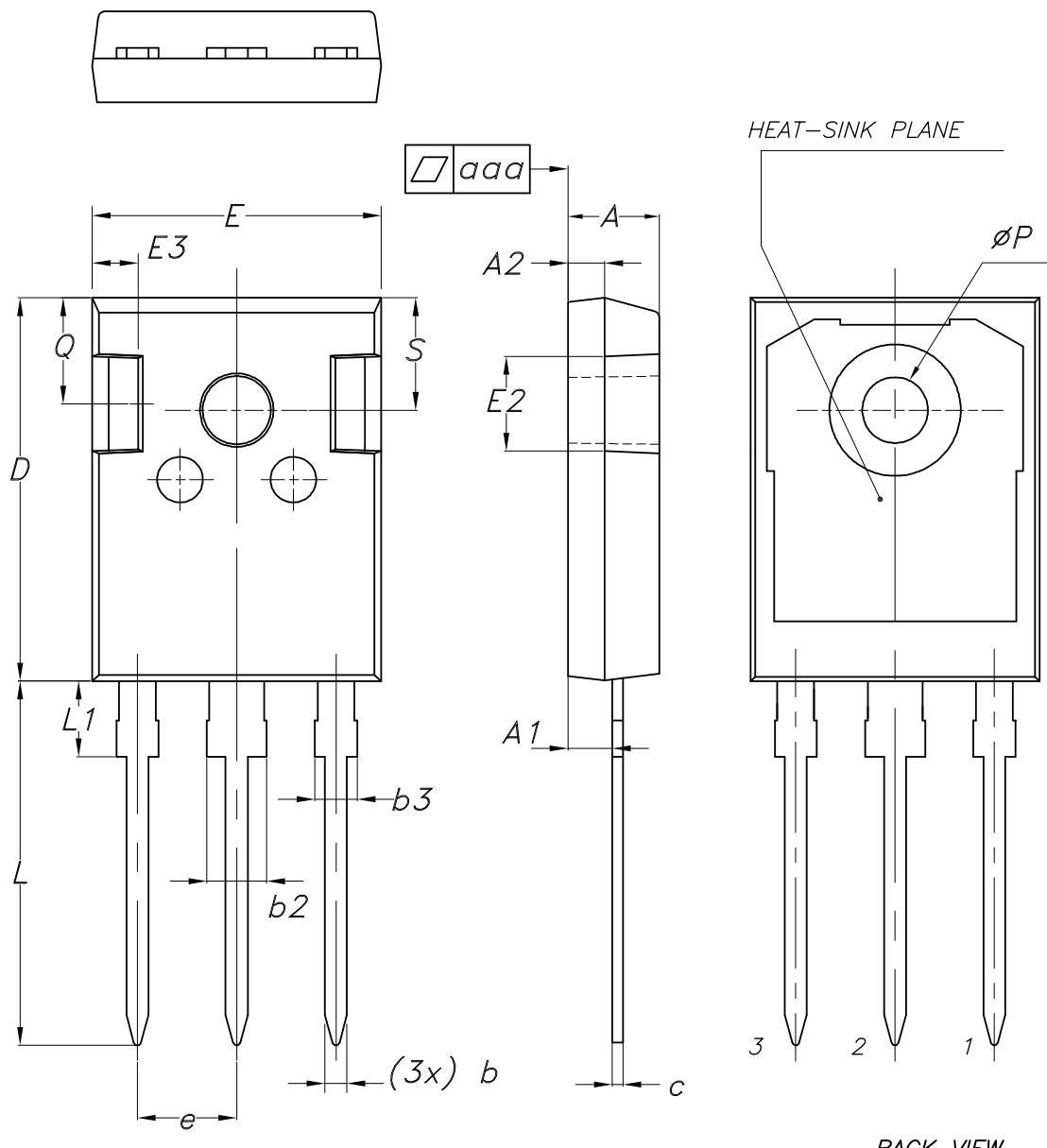
## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 TO-247 long leads package information

Figure 19. TO-247 long leads package outline

DIMENSIONS IN mm



BACK VIEW

8463846\_3

Table 8. TO-247 long leads package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
c	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
P	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25
aaa		0.04	0.10

## Revision history

**Table 9. Document revision history**

Date	Version	Changes
24-Nov-2017	1	First release.
06-May-2020	2	<p>The part number STW68N65DM6 have been moved to a separate datasheet and the document has been updated accordingly.</p> <p>Added <i>Section 2.1 Electrical characteristics (curves)</i>.</p> <p>Modified <i>Table 1. Absolute maximum ratings</i>, <i>Table 3. Avalanche characteristics</i>.</p> <p>Modified <i>Section 2 Electrical characteristics</i>.</p>
19-May-2021	3	<p>Modified <i>Table 1. Absolute maximum ratings</i>, <i>Table 2. Thermal data</i>, <i>Table 4. On/off states</i> and <i>Table 7. Source-drain diode</i>.</p> <p>Minor text changes.</p>

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